HCS370

HCS370 Programming Specifications

1.0 PROGRAMMING THE HCS370

HCS370 devices are programmed using a serial method that differs from previous KEELOQ[®] encoders. This Serial mode will still allow the HCS370 to be programmed while in the users system (ICSP™). This allows for great design flexibility. This programming specification applies to HCS370 devices in all packages.

1.1 Hardware Requirements

The HCS370 requires one programmable power supply for VDD (4.5V to 5.5V) and a VPP of 9V to 14V. Both supplies should have a minimum resolution of 0.25V.

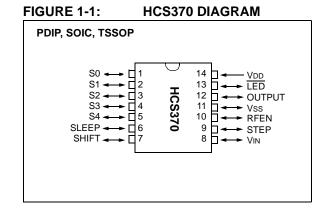


TABLE 1-1: PROGRAMMING PIN DESCRIPTION

Pin Name	Function	HCS370	Pin Type	Pin Description
S0	DATA	1	I/O	Data Input Output
S1	CLOCK	2	I	Clock Input
LED	VPP	13	P(*)	Program mode select
Vss	Vss	11	Р	Ground
Vdd	VDD	14	Р	Power supply

Legend: I = Input, O = Output, P = Power

Note:

In the HCS370, the programming high voltage is internally generated. To activate the Programming mode, high voltage needs to be applied to $\overline{\text{LED}}$ input. This is used as a level source, meaning that $\overline{\text{LED}}$ does not draw any significant current.

1.2 Program Mode Entry

Program mode is entered by holding pins S1 and S0 low while raising VPP pin from VIL to VIHH. All other pins are don't care. Once in Program mode, the entire encoder memory can be accessed and programmed in a serial fashion. S1 and S0 are Schmitt Trigger inputs in this mode. It is important that VDD comes up first and VPP comes up less than 50 μs later.

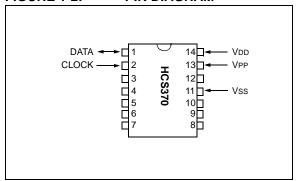
Programming of the device is obtained by writing to two separate memory areas: the encoder memory area and the configuration memory area.

The encoder memory consists of 64 bytes of EEPROM memory and contains the encoder specific data and user configuration options that determine the operation of the device as a KEELOQ encoder. Transmission baud rates, modulation formats and low voltage thresholds are examples of such encoder options.

The configuration memory contains important configuration bits affecting the basic functionality of the device, most of which are factory set and marked as Reserved. The only exception being the Encoder Protect Enable bit, that controls access to the encoder memory area.

In Program mode, all device memory is addressed by means of a single 10-bit Program Counter (PC) that upon entry is set to 3FFh.

FIGURE 1-2: PIN DIAGRAM



1.3 Encoder Memory Map

The encoder memory space is 8-bits wide and extends from address 00h to 7Fh (256 bytes) of which only the first block of 64 bytes is physically implemented from 00h to 3Fh.

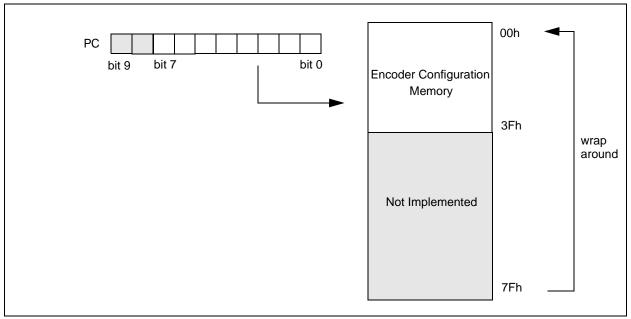
In Program mode this memory is addressed by means of the 8 LSb of the Program Counter (PC), the upper 2 bits of it being ignored.

The non-implemented portion of the addressing space reads always as 0.

Immediately after Program mode entry PC=3FFh, therefore, the Encoder memory address pointed to corresponds to location 0FFh, which is non-implemented.

Note: An Increment Address command is required to move the Program Counter to location 00h.

FIGURE 1-3: ENCODER MEMORY MAPPING



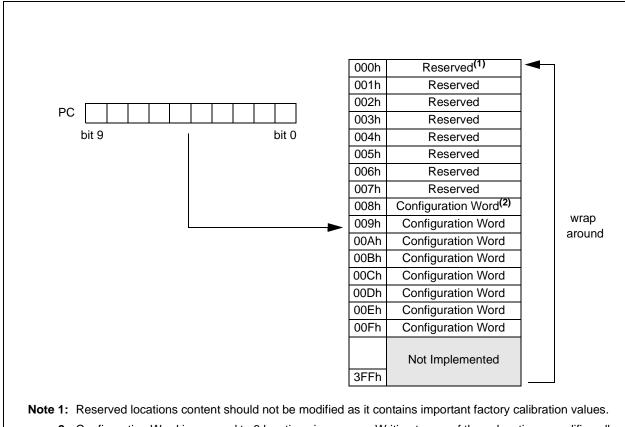
1.4 Configuration Memory Mapping

The device configuration memory space is 12 bits wide and extends from 000h to 3FFh (1 Kbytes). Only the first part, containing 16 words from 000h to 00Fh, is physically implemented and available to the user. The remaining non-implemented portion of the addressing space reads always as 0.

Immediately after Program mode entry PC=3FFh, therefore, the configuration memory address pointed to corresponds to a non-implemented location.

Note: A Load Configuration Memory command followed by an Increment Address command is required to move the Program Counter to location 000h.

FIGURE 1-4: CONFIGURATION MEMORY MAPPING



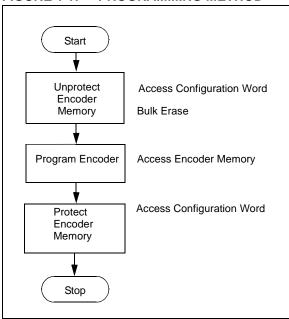
2: Configuration Word is mapped to 8 locations in memory. Writing to any of these locations, modifies all the other locations.

1.5 Programming Method

Programming of the device consists of three basic steps:

- The Configuration Word must be accessed to unprotect the encoder memory, turning the Encoder Protect bit from 0 to 1.
- As a side effect, turning the Encoder Protect bit from 0 back to 1, the encoder memory will be bulk erased (all locations set to 0FFh).
- The encoder memory can now be written with the new encoder data.
- Finally, the Configuration Word is accessed again to protect the encoder memory array.

FIGURE 1-1: PROGRAMMING METHOD



It must be noted that if at the beginning the Encoder Protect bit is not RESET (1), later it will not be possible to modify the contents of the encoder memory.

Failing to set the Encoder Protect bit (0), after writing the new encoder data, on the contrary, will expose the encoder memory contents, including the crypto keys assigned to the device with an extremely severe impact on the security of the customer application.

1.6 The programming sequence

Both when accessing the configuration memory and the encoder memory, a simple basic sequence of four commands is used:

- Load Data command, transfers the data to the write latch ready for the following command
- 2. Begin Programming Cycle command, initiates the self timed memory write sequence
- Read command, verifies the outcome of the previous command
- 4. Increment Address command, so the Program Counter points to the next memory location

This sequence is repeated for the required number of consecutive locations.

In the following sections we will analyze in detail the implementation of such sequence for access to the two memory areas.

1.6.1 CONFIGURATION MEMORY ACCESS

Use the "Load Data For Configuration Memory" command followed by an Increment Address command, immediately after the Program Mode Entry sequence (see Section 1.4). This will set the PC to 000h, eight subsequent "Increment Address" commands will advance into the Configuration Word memory area (008h to 00Fh).

Continue using the "Load Data For Configuration Memory" command in step 1 of the programming sequence.

Use the Read Data From Configuration Memory command in step 3 of the programming sequence.

1.6.2 ENCODER MEMORY ACCESS

Use the "Increment Address" command immediately after the Program mode entry sequence. This will set the Program Counter to 00h where the actual Encoder programming sequence can start. (see Section 1.3)

Use the "Load Data For Encoder Memory" command in step 1 of the programming sequence.

Use the "Read Data From Encoder Memory" command in step 3 of the programming sequence.

1.6.3 RESERVED LOCATIONS

It is important that the programmer does not modify the content of any of the reserved locations as this might affect some of the factory programmed calibration parameters of the device such as the brown-out threshold levels or the internal RC oscillator frequency.

1.7 Serial Programming Operation

The S1 pin is used as a clock input pin and the S0 pin is used for entering command bits and data input/out-put during serial operation. To input a command, the clock pin (S1) is cycled 6 times. Each command bit is latched on the falling edge of the clock with the Least Significant bit (LSb) of the command being input first. The data on pin S0 is required to have a minimum setup and hold time of 100 ns, with respect to the falling edge of the clock. Commands that have data associated with them (read and load) are specified to have a minimum delay of 1 µs, between the command and the data. After this delay, the clock pin is cycled 16 times,

with the first cycle being a START bit, followed by 12 data bits, two zeros and the last cycle being a STOP bit. START and STOP bits are also set to zero.

Data is input and output LSb first. Data is set on the rising edge of the clock and latched on the falling edge of the clock. Therefore, during a read operation, the LSb will be transmitted onto pin S0 on the rising edge of the second cycle, and during a load operation, the LSb will be latched on the falling edge of the second cycle. To allow for decoding of commands and reversal of data pin configuration, a time separation, of at least 1 μ s, is required between a command and a data word (or another command).

FIGURE 1-5: SERIAL COMMAND EXAMPLE

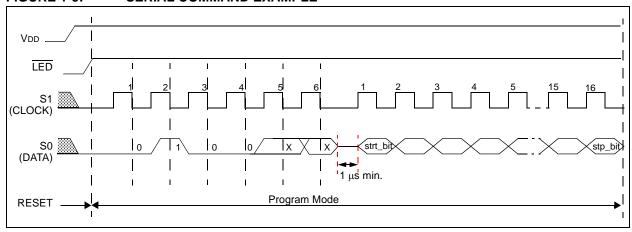


TABLE 1-2: SERIAL PROGRAMMING COMMAND SET

Command	(MSb LSb)	Data (order of input/output) START bit, data LSb data MSb, padding, STOP bit							
Load Data For Configuration Memory	0 0 0 0 0 0	0 d0 d1 d2 d3 d4 d5 d6 d7 d8 d9 d10 d11 0 0 0							
Load Data For Encoder Memory	0 0 0 0 1 1	0 d0 d1 d2 d3 d4 d5 d6 d7 0 0 0 0 0 0							
Read Data From Configuration Memory	0 0 0 1 0 0	0 d0 d1 d2 d3 d4 d5 d6 d7 d8 d9 d10 d11 0 0 0							
Read Data From Encoder Memory	0 0 0 1 0 1	0 d0 d1 d2 d3 d4 d5 d6 d7 0 0 0 0 0 0							
Increment Address	0 0 0 1 1 0								
Begin Erase / Programming Cycle	0 0 1 0 0 0								
Begin Programming Only Cycle	0 0 1 0 1 0								
Bulk Erase Encoder Memory	0 0 1 0 1 1								

Note: All other 6-bit combinations are Reserved.

1.7.1 LOAD DATA FOR CONFIGURATION MEMORY

After receiving this command, the program counter (PC) will be set to 3FFh. An "Increment Address" command will then advance the PC to 000h pointing to the Configuration Word memory. By then applying 16 cycles to the clock pin, the chip will load 12 bits in, as the "data word".

1.7.2 LOAD DATA FOR ENCODER MEMORY

After receiving this command, the chip will load in 12 bits as a "data word" when 16 cycles are applied. However, the encoder memory is only 8-bits wide, and thus, only the first 8 bits of data after the START bit will be programmed into the data memory. It is still necessary to cycle the clock the full 16 cycles in order to allow the internal circuitry to RESET properly.

The PC is used to address the encoder memory. Only the lower 8 bits of the PC are decoded by the encoder memory. Locations 0h-3Fh are physically implemented, while locations 40h-FFh are not implemented and read as zeroes (low). If the PC is greater than FFh, it will wrap around and address a location from 0h-FFh.

1.7.3 READ DATA FROM CONFIGURATION MEMORY

After receiving this command, the chip will transmit data bits out of the configuration memory currently accessed, starting with the second rising edge of the clock input. The S0 pin will go into Output mode on the second rising clock edge, and it will revert back to Input mode (hi-impedance) after the 16th rising edge.

Configuration Word memory will read irrespective of the Encoder Protect enable bit status.

1.7.4 READ DATA FROM ENCODER MEMORY

After receiving this command, the chip will transmit data bits out of the data memory starting with the second rising edge of the clock input. The S0 pin will go into Output mode on the second rising clock edge, and it will revert back to Input mode (hi-impedance) after the 16th rising edge. As previously stated, the data memory is 8-bits wide, and therefore, only the first 8 bits that are output are actual data. A timing diagram for this read command is shown in Figure 5-2.

If the Encoder Protect mechanism is enabled, all the Encoder configuration data will read as zeros. Writing to the encoder memory will also be disabled.

1.7.5 INCREMENT ADDRESS

The PC is incremented when this command is received. A timing diagram of this command is shown in Figure 5-3.

1.7.6 BEGIN ERASE/PROGRAMMING CYCLE

A Load command must be given before every Begin Programming command. Word erasure and programming of Configuration Word and encoder memory will begin, after this command is received and decoded. An internal timing mechanism executes an erase before write. The user must allow the combined time for erase and programming, as specified in the electrical specs, for programming to complete. No "End Programming" command is required.

1.7.7 BEGIN PROGRAMMING ONLY CYCLE

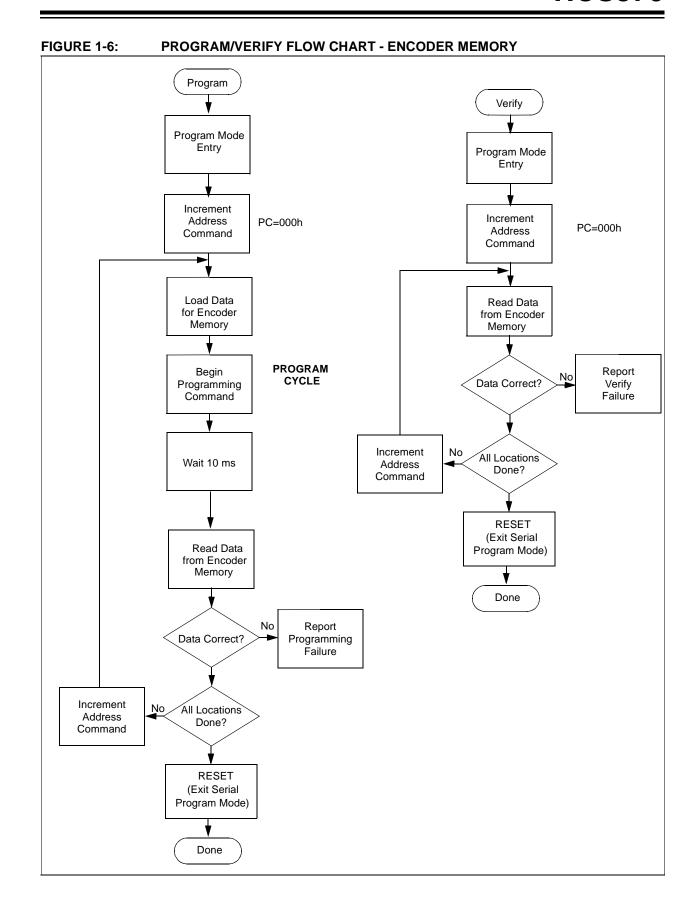
This command is similar to the Erase/Programming Cycle command, except that a word erase is not done. Programming Configuration Word and encoder memory will begin after this command is received and decoded. The user must allow the time for programming, as specified in the electrical specs, for programming to complete. No "End Programming" command is required.

It is recommended that the user do a bulk erase before starting a series of programming only cycles.

1.7.8 BULK ERASE ENCODER MEMORY

After this command is performed, the "Next Program" command will erase the entire encoder memory. The erase time is specified to be 10 ms.

All bulk erase operations must take place at 4.5 to 5.5V VDD range.



2.0 CONFIGURATION WORD

Special care must be taken when modifying the Configuration Word contents of the HCS370. In fact, in addition to the Encoder Protection enable bits, it contains several "factory calibration" parameters that are vital to the proper working of the device (marked Reserved).

Care must be taken not to lose these bits contents when manipulating the Configuration Word.

Writing the Configuration Word requires further consideration of the following constraints:

- writing will be performed only if the Encoder Protect bit differs from the current Configuration Word contents
- changing from 0 to 1, the Encoder Protect bit will produce a bulk erase of the encoder memory contents

Refer to Figure 2-1 (PROGRAM FLOW CHART - CONFIGURATION WORD) to learn how to access and program the Configuration Word of an HCS370 device.

TABLE 2-1: CONFIGURATION WORD BIT MAP

Res	Res	Res	Res	Res	EP	Res	Res	Res	Res	Res	Res
bit 11		bit 6 bit 0									
Res:	Reserved	Reserved, preserve value of these bits when writing to the Configuration Word									
bit 6:	EP: Enco	der Protect	ion enable	bit							

Setting the bit from 0 to 1 removes read protection and bulk erases the Encoder EEPROM 1 = Not protected

0 = Protected - Can not read or write

2.1 Encoder Protection

The HCS370 features an Encoder Protection mechanism to control access to the encoder memory array. When Encoder Protection is enabled, the encoder memory locations read all '0's. Further programming is disabled for the entire array.

Once Encoder Protection has been enabled, disabling it will produce a bulk erase of the entire encoder memory array.

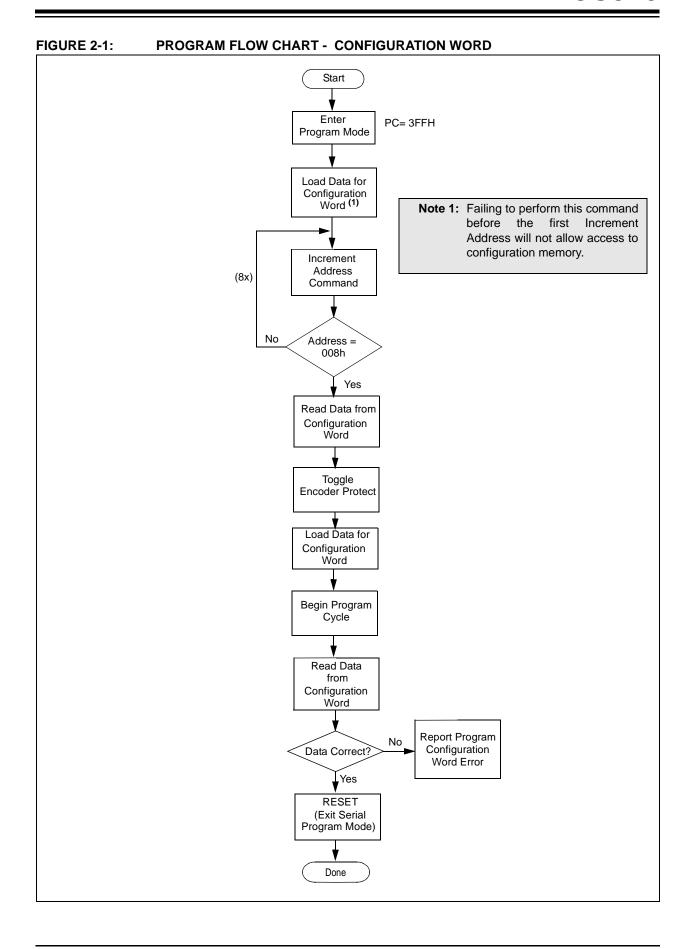
Configuration memory is not affected by the Encoder Protect bits and is always available to read.

Note: Failing to set the Encoder Protect bit (0), after writing new encoder data will expose the encoder memory contents, including the crypto keys assigned to the device, with an extremely severe impact on the security of the customer application.

TABLE 2-2: CODE PROTECTION

Memory Segment	R/W Protected (EP = 0)	R/W Unprotected ($\overline{EP} = 1$)
Configuration Memory [000h:00Fh]	Read Enabled, Write Enabled*	Read Enabled, Write Enabled*
Encoder memory [000h:03Fh]	Read Disabled (all 0's), Write Disabled	Read Enabled, Write Enabled

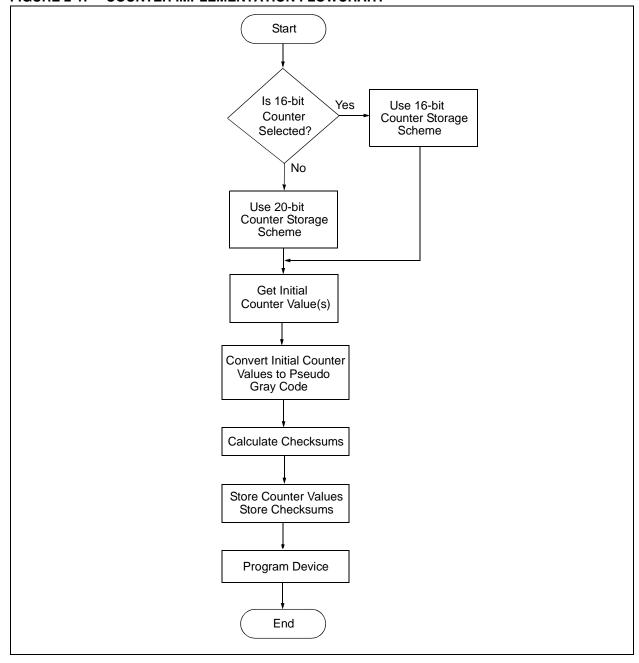
Note*: The Configuration Word is not updated unless EP is changed from existing value.



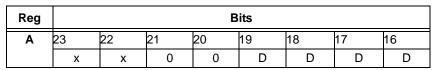
2.2 HCS370 Counter Implementation

The HCS370 uses a different method of storing the counter in EEPROM when compared to previous KEELOQ encoders. This section explains how to implement this different counter storage method and provides some examples for testing purposes.

FIGURE 2-1: COUNTER IMPLEMENTATION FLOWCHART



20-Bit Counter:



MSb

	Reg		Bits									
ĺ	В	15	14	13	12	11	10	9	8			
		D	D	D	D	D	D	D	D			

Reg		Bits								
С	7	6 5 4 3 2 1 0								
	D	D	D	D	D	D	D	D		

LSb

- D represents a counter bit
- · x represents a don't care
- 0 represents a logic zero

16-Bit Counter:

Reg		Bits									
Α	23	22	21	20	19	18	17	16			
	Х	х	0	0	0	0	F	F			

MSb

F	Reg		Bits									
	В	15	14	13	12	11	10	9	8			
		D	D	D	D	D	D	D	D			

Reg		Bits									
С	7	6 5 4 3 2 1 0									
	D	D	D	D	D	D	D	D			

LSb

- D represents a counter bit
- x represents a don't care
- 0 represents a logic zero
- FF represents overflow conditions.

FF = 11 -> None

FF = 01 -> Once

FF = 00 -> Twice

Convert Initial Counter Values to Pseudo Gray Code (C Implementation):

Note: See previous page for references to A, B, and C.

If (B&1)

 $C \stackrel{\wedge}{=} 0xFF;$

If (A&1)

B = 0xFF;

Calculate Checksums (C implementation):

Checksum1 = B^C;

Checksum2 = A^C;

Checksum $3 = A^B$;

Store Counter Values And Checksums:

Note: Checksum 3 comes before Checksum 2

For HCS370 Transmitter #1

		Bits									
Address	7	6	5	4	3	2	1	0			
00		A									
01		В									
02					С						
03				Chec	ksum 1						
04		Checksum 3									
05				Chec	ksum 2						

		Bits										
Address	7	6	5	4	3	2	1	0				
08					Α							
09		В										
0A		С										
0B				Chec	ksum 1							
0C		Checksum 3										
0D				Chec	ksum 2							

Example 1:

Counter Scheme: 16-bit Counter Value: 0x0000 Overflow Condition: None

Reg		Bits								
Α	23	22	21	20	19	18	17	16		
	0	0	0	0	0	0	1	1		

MSb

Reg		Bits								
В	15	5 14 13 12 11 10 9 8								
	0	0	0	0	0	0	0	0		

Reg		Bits								
С	7	6	5	4	3	2	1	0		
	0	0	0	0	0	0	0	0		

LSb

Get Initial Counter Values:

A = 0x03

B = 0x00

C = 0x00

Convert Initial Counter Values To Pseudo Gray Code (See page 12):

 $A = \mathbf{0}\mathbf{x}\mathbf{0}\mathbf{3}$

B = 0xFF

C = 0x00

Calculate Checksums:

Checksum1= B \oplus C = 0xFF \oplus 0x00 = **0xFF**

Checksum2= $A \oplus C = 0x03 \oplus 0x00 = 0x03$

Checksum3= $A \oplus B = 0x03 \oplus 0xFF = 0xFC$

Store Counter Values And Checksums:

				В	its						
Address	7	6	5	4	3	2	1	0			
00		A = 0x03									
01		B = 0xFF									
02		C = 0x00									
03		Checksum 1 = 0xFF									
04		Checksum 3 = 0xFC									
05		Checksum 2 = 0x03									

Example 2:

Counter Scheme: 16-bit Counter Value: 0x1234 Overflow Condition: Once

Reg				В	its			
Α	23	22	21	20	19	18	17	16
	0	0	0	0	0	0	0	1

MSb

Reg		Bits								
В	15	14	13	12	11	10	9	8		
	0	0	0	1	0	0	1	0		

Reg				В	its			
С	7	6	5	4	3	2	1	0
	0	0	1	1	1	0	0	0

LSb

Get Initial Counter Values:

A = 0x01

B = 0x12

C = 0x34

Convert Initial Counter Values To Pseudo Gray Code (See page 12):

 $A = \mathbf{0}\mathbf{x}\mathbf{0}\mathbf{1}$

B = 0xED

C = 0x34

Calculate Checksums:

Checksum1= B \oplus C = 0xED \oplus 0x34 = **0xD9**

Checksum2= $A \oplus C = 0x01 \oplus 0x34 = 0x35$

Checksum3= $A \oplus B = 0x01 \oplus 0xED = 0xEC$

Store Counter Values And Checksums:

		Bits									
Address	7	6	5	4	3	2	1	0			
00					A = 0x01						
01		B = 0xED									
02		C = 0x34									
03		Checksum 1 = 0xD9									
04				Chec	ksum 3 =	0xEC					
05				Chec	cksum 2 =	0x35					

Example 3:

Counter Scheme: 16-bit Counter Value: 0x789A Overflow Condition: Twice

Reg		Bits								
Α	23	22	21	20	19	18	17	16		
	0	0	0	0	0	0	0	0		
			•							

MSb

Reg		Bits								
В	15	5 14 13 12 11 10 9 8								
	0	1	1	1	1	0	0	0		

Reg		Bits								
С	7	6	5	4	3	2	1	0		
	1	0	0	1	1	0	1	0		

LSb

Get Initial Counter Values:

A = 0x00

B = 0x78

C = 0x9A

Convert Initial Counter Values To Pseudo Gray Code (See page 12):

 $A = \mathbf{0}\mathbf{x}\mathbf{0}\mathbf{0}$

B = 0x78

C = 0x9A

Calculate Checksums:

Checksum1= B \oplus C = 0x78 \oplus 0x9A = **0xE2**

Checksum2= $A \oplus C = 0x00 \oplus 0x9A = 0x9A$

Checksum3= $A \oplus B = 0x00 \oplus 0x78 = 0x78$

Store Counter Values And Checksums:

				E	3its						
Address	7	6	5	4	3	2	1	0			
00		A = 0x00									
01		B = 0x78									
02		C = 0x9A									
03		Checksum 1 = 0xE2									
04		Checksum 3 = 0x78									
05		Checksum 2 = 0x9A									

Example 4:

Counter Scheme: 20-Bit Counter Value: 0xFABCD

	Reg		Bits								
ľ	Α	23	22	21	20	19	18	17	16		
		0	0	0	0	1	1	1	1		

MSb

Reg	Bits							
В	15	14	13	12	11	10	9	8
	1	0	1	0	1	0	1	1

Reg		Bits							
С	7	6	5	4	3	2	1	0	
	1	1	0	0	1	1	0	1	

LSb

Get Initial Counter Values:

A = 0x0F

B = 0xAB

C = 0xCD

Convert Initial Counter Values To Pseudo Gray Code (See page 12):

A = 0x0F

B = 0x54

C = 0x32

Calculate Checksums:

Checksum1= B \oplus C = 0x54 \oplus 0x32 = **0x66**

Checksum2= $A \oplus C = 0x0F \oplus 0x32 = 0x3D$

Checksum3= $A \oplus B = 0x0F \oplus 0x54 = 0x5B$

Store Counter Values And Checksums:

		Bits								
Address	7	6	5	4	3	2	1	0		
00		A = 0x0F								
01		B = 0x54								
02					C = 0x32					
03				Chec	ksum 1 =	0x66				
04				Chec	ksum 3 =	0x5B				
05				Chec	ksum 2 =	0x3D				

3.0 EEPROM ORGANIZATION

A summary of the HCS370 EEPROM organization is shown in the table below.

TABLE 3-1: HCS370 MEMORY MAP

					Bits				
Bytes	7	6	5	4	3	2	1		0
00				SYNC COL	JNTER TX#1 USB				
01				SYNC COL	JNTER TX#1 MSB				
02				SYNC CO	JNTER TX#1 LSB				
03				SYNC COUNT	ER TX#1 CHKSUN	11			
04				SYNC COUNT	ER TX#1 CHKSUN	13			
05				SYNC COUNT	ER TX#1 CHKSUN	12			
06				RE	SERVED				
07				RE	SERVED				
08				SYNC COL	JNTER TX#2 USB				
09				SYNC COL	JNTER TX#2 MSB				
0A				SYNC COL	JNTER TX#2 LSB				
0B				SYNC COUNT	ER TX#2 CHKSUN	11			
0C				SYNC COUNT	ER TX#2 CHKSUN	13			
0D				SYNC COUNT	ER TX#2 CHKSUN	12			
0E				RE	SERVED				
0F				RE	SERVED				
10				32-BIT SERIAL	NUMBER TX #1 (M	ISB)			
11				32-BIT SERI	AL NUMBER TX #				
12				32-BIT SERI	AL NUMBER TX #				
13		32-BIT SERIAL NUMBER TX#1 (LSB)							
14		4-BIT SEE	D CODE TX#1		60	-BIT SEED_1 \	/ALUE (MS-NIE	3BLE)	
15		60-BIT SEED_1 VALUE							
16				60-BIT S	SEED_1 VALUE				
17		60-BIT SEED_1 VALUE							
18				60-BIT S	SEED_1 VALUE				
19				60-BIT S	SEED_1 VALUE				
1A				60-BIT S	SEED_1 VALUE				
1B				60-BIT SEE	D_1 VALUE (LSB)				
1C	STEN_1	QUEN_1	XSER_1	HSEL_1	MSE	L_1	DISC_	_1H (MS-B	BITS)
1D				DIS	C_1L (LSB)				
1E				64-BIT	KEY_1 (MSB)				
1F				64-	BIT KEY_1				
20				64-	BIT KEY_1				
21				64-	BIT KEY_1				
22				64-	BIT KEY_1				
23				64-	BIT KEY_1				
24				64-	BIT KEY_1	·			
25				64-BIT	KEY_1 (LSB)				
26				32-BIT SERIAL	NUMBER TX#2 (M	SB)			
27				32-BIT SER	IAL NUMBER TX#2	2			
28				32-BIT SER	IAL NUMBER TX#2	2			
29				32-BIT SERIAL	NUMBER TX#2 (L	SB)			
2A		4-BIT SEE	D CODE TX#2		60	-BIT SEED_2 \	/ALUE (MS-NIE	3BLE)	
2B				60-BIT S	SEED_2 VALUE				
2C				60-BIT S	SEED_2 VALUE				
2D				60-BIT S	SEED_2 VALUE				
2E				60-BIT S	SEED_2 VALUE				
2F				60-BIT S	SEED_2 VALUE			_	-

HCS370

					Bits					
Bytes	7 6 5 4 3 2 1							0		
30		60-BIT SEED_2 VALUE								
31				60-BIT SEEI	D_2 VALUE (LSB))				
32	STEN_2	QUEN_2	XSER_2	HSEL_2	MSE	L_2	DISC_2H	(MS-BITS)		
33		DISC_2L (LSB)								
34		64-BIT KEY_2 (MSB)								
35		64-BIT KEY_2								
36		64-BIT KEY_2								
37				64-B	IT KEY_2					
38				64-B	IT KEY_2					
39				64-B	IT KEY_2					
3A				64-B	IT KEY_2					
3B				64-BIT I	KEY_2 (LSB)					
3C	GSI	EL_1	BS	EL_1	SDT	M_1	SDMD_1	SDLM_1		
3D	LEDOS_2	LEDBL_2	TSEL		SLEEP	WAIT	M	TX		
3E	GSI	EL_2	BS	EL_2	SDT	M_2	SDMD_2	SDLM_2		
3F	LEDOS_1	LEDBL_1	PLLSEL	VLOWSEL	VLOWL CNTSEL		WA	KE		

4.0 ENCODER CONFIGURATION OPTIONS SUMMARY

Data stored in the EEPROM can be classified as Encoder configuration (E) or System Configuration (S). In the case of dual Encoder Operation, two copies of the Encoder configuration must be stored for Encoder 1 and Encoder 2.

TABLE 4-1: FIRST ENCODER CONFIGURATION OPTIONS

Symbol	Address Bits	Class	Description (Note 1)						
SYNC_1	00: 16 bits	E	Encoder Synchronization Counter (CNTSEL=1)						
SER_1	10: 32 bits	E	Encoder Serial Number						
SDBT_1	14: 7654	Е	Seed Button Code						
SEED_1	14: 60 bits	E	Encoder Seed Value						
STEN_1	1C: 7	E	START/STOP Pulse Enable	Enable = 1					
QUEN_1	1C: -6	E	Queue counter Enable	Disable = 0	Enable = 1				
XSER_1	1C:5	Е	Extended Serial Number	28 bits = 0	32 bits = 1				
HSEL_1	1C:4	E	Header Select	4 TE = 0	10 TE = 1				
MSEL_1	1C:32	Е	Transmission Modulation Format	Value	Format				
				00b	PWM				
				01b	Manchester				
				10b	VPWM				
				11b	PPM				
DISC_1h	1C:10	Е	Encoder Discrimination value (2 MS						
DISC_1I	1D: 8 bits	Е	Encoder Discrimination value (8 LSB)						
KEY_1	1E: 64 bits	Е	Encoder Key						
SDLM_1	3C:0	Е	Limited Seed Disable = 0		Enable = 1				
SDMD_1	3C:1-	Е	Seed Mode	User = 0	Production = 1				
SDTM_1	3C:32	E	Time Before Seed Code Word	Value	Time (s)				
				00b	0.0				
				01b	0.8				
				10b	1.6				
				11b	3.2				
BSEL_1	3C:54	Е	Transmission Baud Rate Select	Value	TE (μs)				
				00b	100				
				01b	200				
				10b	400				
				11b	800				
GSEL_1	3C: 76	Е	Guard Time Select	Value	Time (ms)				
				00b	0.0				
				01b	6.4				
				10b	51.2				
				11b	102.4				
LEDBL_1	3F: -6	Е	Low Voltage LED Blink	Continuous = 0	Once = 1				
LEDOS_1	3F: 7	Е	LED On Time Select	LED On Time Select 50 ms = 0 100 ms = 1					

Note 1: All Timing values vary ±10%.

TABLE 4-2: SECOND ENCODER CONFIGURATION OPTIONS

Symbol	Address Bits	Class	Description (Note 1)						
SYNC_2	08: 20 bits	Е	Encoder Synchronization Counter (CNTSEL=1)						
SER_2	26: 32 bits	Е	Encoder Serial Number						
SDBT_2	2A: 7654	Е	Seed Button Code						
SEED_2	2A: 60 bits	Е	Encoder Seed Value						
STEN_2	32: 7	Е	START/STOP Pulse Enable	START/STOP Pulse Enable Disable = 0					
QUEN_2	32: -6	Е	Queue counter Enable	Disable = 0	Enable = 1				
XSER_2	32:5	Е	Extended Serial Number	28 bits = 0	32 bits = 1				
HSEL_2	32:4	Е	Header Select	4 TE = 0	10 TE = 1				
MSEL_2	32:32	Е	Transmission Modulation Format	Value	Format				
				00b	PWM				
				01b	Manchester				
				10b	VPWM				
				11b	PPM				
DISC_2h	32:10	Е	Encoder Discrimination value (2 MSE	3)					
DISC_2I	33: 8 bits	Е	Encoder Discrimination value (8 LSB)						
KEY_2	34: 64 bits	Е	Encoder Key						
SDLM_2	3E:0	Е	Limited Seed	Disable = 0	Enable = 1				
SDMD_2	3E:1-	Е	Seed Mode	User = 0	Production = 1				
SDTM_2	3E:32	Е	Time Before Seed Code Word	Value	Time (s)				
				00b	0.0				
				01b	0.8				
				10b	1.6				
				11b	3.2				
BSEL_2	3E:54	Е	Transmission Baud Rate Select	Value	TE (μs)				
				00b	100				
				01b	200				
				10b	400				
				11b	800				
GSEL_2	3E: 76	Е	Guard Time Select	Value	Time (ms)				
				00b	0.0				
				01b	6.4				
				10b	51.2				
				11b	102.4				
LEDBL_2	3D: -6	E	Low Voltage LED Blink	Continuous = 0	Once = 1				
LEDOS_2	3D: 7	Е	LED On Time Select 50 ms = 0 100 ms = 1						

Note 1: All Timing values vary ±10%.

TABLE 4-3: SYSTEM CONFIGURATION OPTIONS

Symbol	Address Bits	Class	Description (Note 1)					
MTX	3D:10	S	Minimum Code Words	Value	Value			
				00b	1			
				01b	2			
				10b	4			
				11b	8			
WAIT	3D:2	S	Wait for Step Up regulator	Disable = 0	Enable = 1			
SLEEP	3D:3	S	SLEEP Output Enable	Disable = 0	Enable = 1			
TSEL	3D:54	S	Time-out Select	Value	Time (s)			
				00b	Disabled			
				01b	0.8			
				10b	3.2			
				11b	25.6			
WAKE	3F:10	S	Wake-up	Value	Value			
				00b	No Wake-up			
			01b	75 ms 50%				
				10b	50 ms 33.3%			
				11b	100 ms 16.6%			
CNTSEL	3F:2	S	Counter Select	16 bits = 0	20 bits = 1			
VLOWL	3F:3	S	Low Voltage Latch Enable	Disable = 0	Enable = 1			
VLOWSEL	3F:4	S	Low Voltage Trip Point Select	2.2 V = 0	3.2V = 1			
PLLSEL	3F:5	S	PLL Interface Select	ASK = 0	FSK = 1			

Note 1: All Timing values vary ±10%.

5.0 PROGRAM MODE ELECTRICAL CHARACTERISTICS

TABLE 5-1: AC/DC TIMING REQUIREMENTS FOR PROGRAM MODE

AC/DC CHARACTERISTICS, POWER SUPPLY PINS

POWER SUPPLY PINS											
Characteristics	Sym	Min	Тур	Max	Units	Conditions/Comments					
	General										
Supply voltage during programming	Vbatt	4.5	5.0	5.5	V						
Supply voltage during verify	Vbatt	VDD min.		V _{DD} max.	V						
High voltage on MCLR Test mode entry	Vihh	VBATT + 4.5		14.0	V	Always use minimum on VIHH					
Power-up Reset time before entering Test mode	tvdd		50		μS						
MCLR rise time (Vss to Vhh) for Test mode entry	tvhhr			1.0	ms						
(S1, S0) input high level	Vih1	0.8Vbatt			V	Schmitt Trigger input					
(S1, S0) input low level	Vil1	0.2VBATT			V	Schmitt Trigger input					
S<3:0> setup time before MCLR (Test mode selection pattern setup time)	tset0	100			ns						
S<3:0> hold time after MCLR (Test mode selection pattern setup time)	thld0	5			ms						
	;	Serial Program	n/Verify								
Data in setup time before clock	tset1	100			ns						
Data in hold time after clock	thld1	100			ns						
Data input not driven to next clock input (delay required between command/data or command/command)	tdly1	1.0			μЅ						
Delay between clock to clock of next command or data	tdly2	1.0			μS						
Clock to data out valid (during read data)	tdly3	80			ns						
Serial Clock Period		1			μS						
Erase Cycle Time				10	ms						
Program Cycle Time				10	ms						

FIGURE 5-1: LOAD DATA FOR CONFIG MEMORY COMMAND

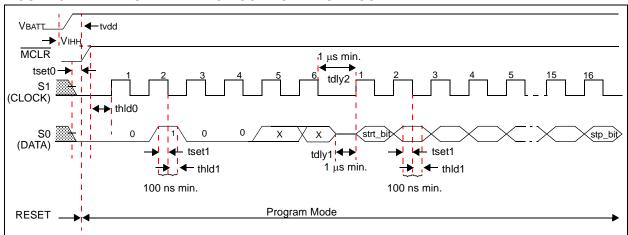


FIGURE 5-2: READ DATA FROM ENCODER MEMORY COMMAND

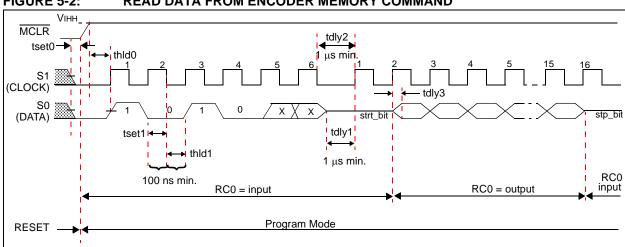
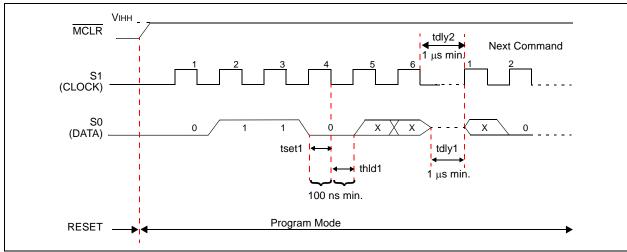


FIGURE 5-3: INCREMENT ADDRESS COMMAND



HCS370

6.0 ADDITIONAL INFORMATION

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